IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of :

Venkatesh Gopinath
Arvind Kamath
Mohammad Mirabedini
Ming-Yi Lee

Serial No. :	09/991,202	**Group Art Unit :**	2812
Filed :	November 14, 2001	**Examiner :**	Isaac, Stanetta D.
For :	Shallow Trench Isolation Structure With Low Trench Parasitic Capacitance	**Atty Docket :**	/ 01-555

I hereby certify that this correspondence is being deposited with the U.S. Postal Service as First Class Mail in an envelope addressed to: Commissioner for Patents, P. O. Box 1450, Alexandria, VA 22313-1450, on the date below:

Manu Kashyap

11-4-05 (Date) (Signature)

SUBMISSION OF FORMAL DRAWINGS PURSUANT TO 37 C.F.R. §1.85

Official Draftsman

Commissioner for Patents
P. O. Box 1450
Alexandria, VA 22313-1450

Sir:

Applicant hereby substitutes the enclosed formal drawings for those presently in the above referenced application.

LSI Logic Corporation
1621 Barber Lane, MS D-106
Milipitas, CA 95035
408-433-7475

Respectfully submitted,

Timothy Croll

Reg. No. 36,771

Date: 4Nov05